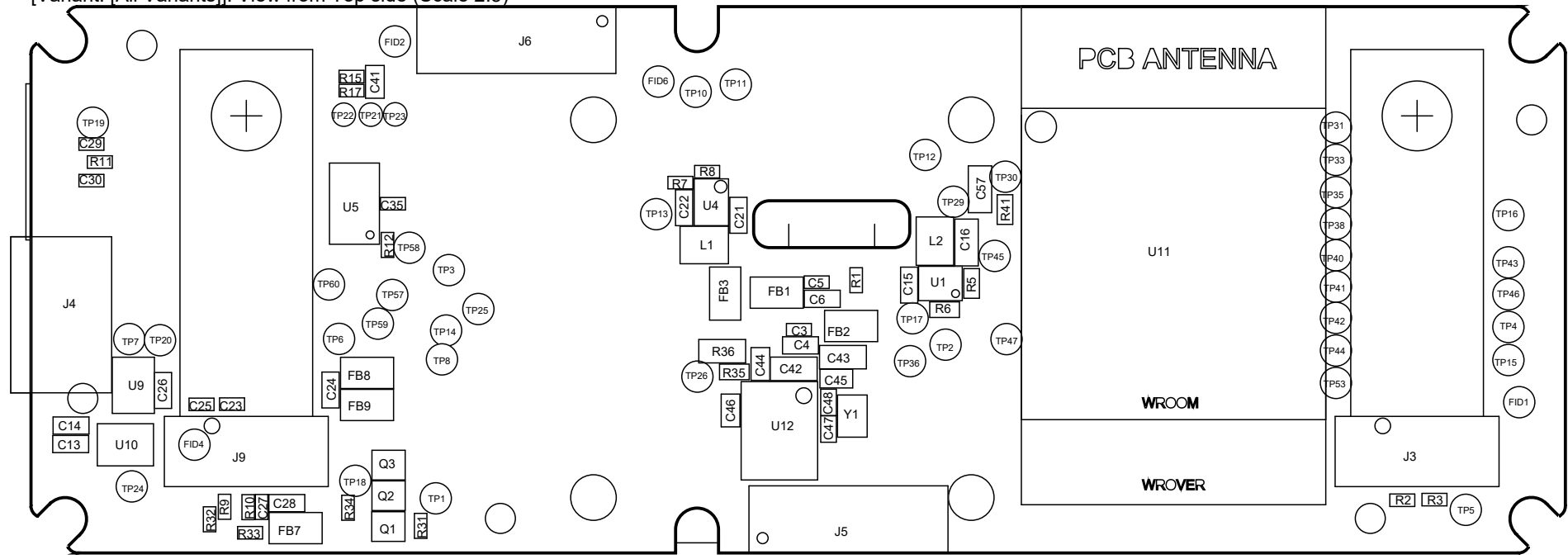


ASSEMBLY NOTES:

Assembly shall conform to IPC-A-610 Class 2.  
Assembly shall conform with RoHS Directive 2011/65/EU.  
Components shall be placed according to the associated CPL and BOM documents.  
Lead-free SAC305 solder shall be used.  
Reflow profile shall comply with J-STD-20C Lead-Free Reflow Profile.  
BGA components shall be be 100% checked with x-ray for solder bridges after reflow.  
Finished assemblies shall be removed from panel prior to delivery.

[Variant: [All Variants]]: View from Top side (Scale 2.5)



A

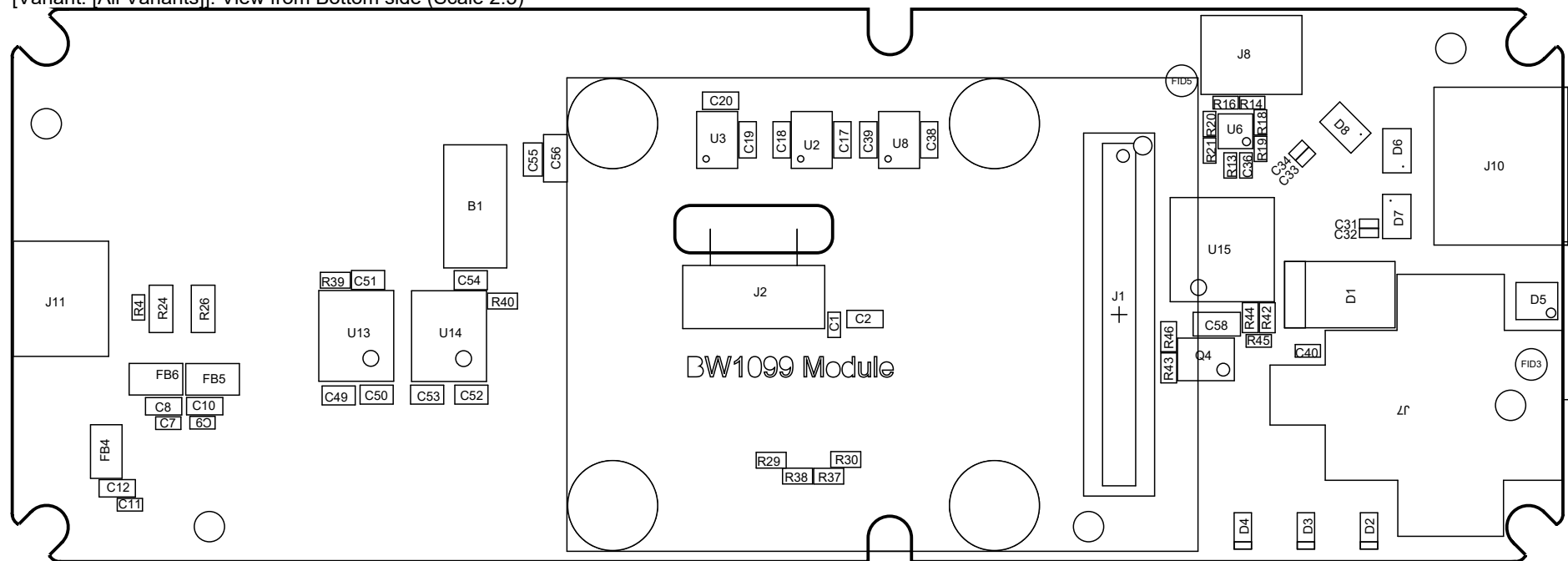
B


C

D

E

[Variant: [All Variants]]: View from Bottom side (Scale 2.5)



Title: <b>DM1098OAKD_WIFI</b>		
Number: DXXXX	Revision: R0M0 E0	
Date: 21/01/2021	Sheet: 2 of 3	
Drawn by: David Malovrh		
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A

B

C

D

E

A

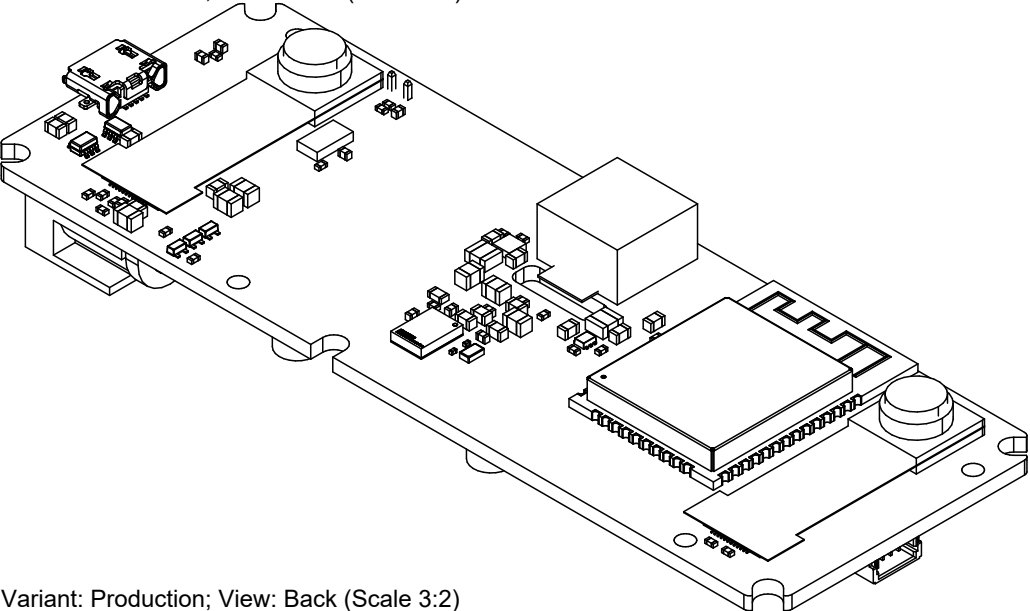
B

C

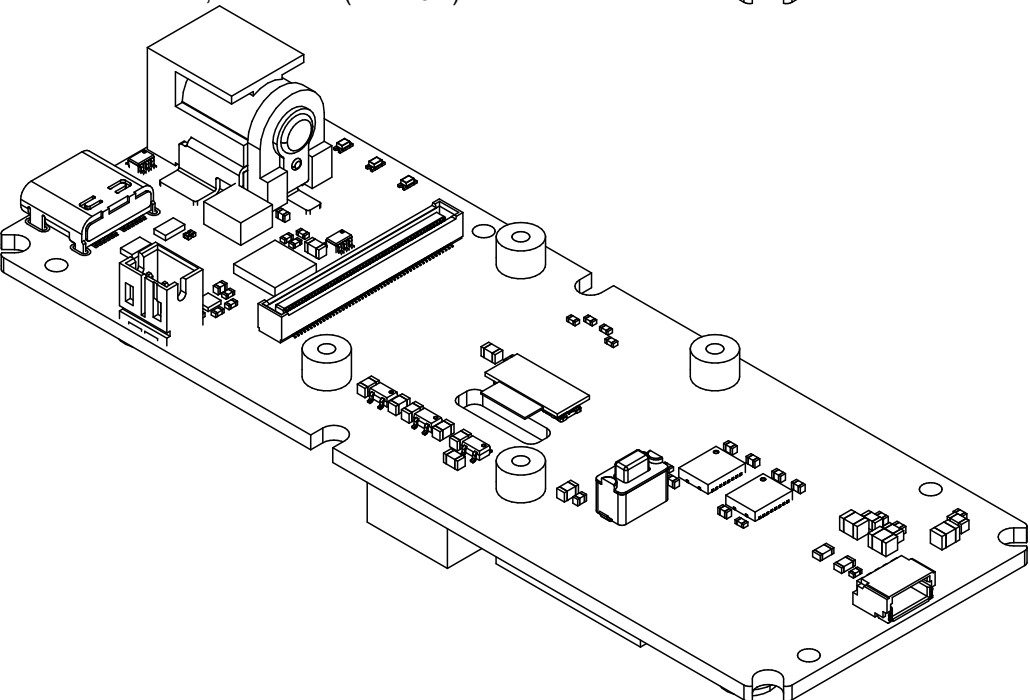
D

E

Variant: Production; View: Front (Scale 3:2)

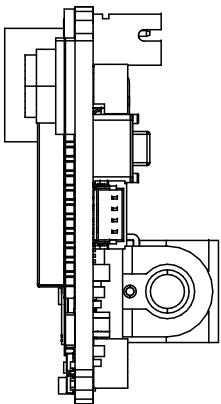
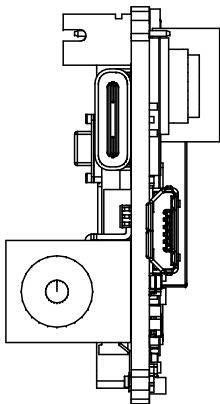


Variant: Production; View: Back (Scale 3:2)



These drawings shown with "Production" variant.

Variant: Production; View: Left (Scale 3:2)



Variant: Production; View: Right (Scale 3:2)

Title: **DM1098OAKD\_WIFI**

Number: DXXXX

Revision: R0M0  
E0

Date: 21/01/2021

Sheet: 3 of 3

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